

Status:	CLOSED	Start date:	2023-03-13
Priority:	Normal	Due date:	
Assignee:	SZ-硬件二组_SD3 王苗	% Done:	0%
Category:	依赖硬件解决bug	Estimated time:	0.00 hour
Target version:			
Need_Info:	--	Found Version:	2023.02.15
Resolution:	--	Degrated:	--
Severity:	Normal	Verified Version:	
Reproducibility:	Every time	Fixed Version:	
Test Type:	Release Test	Root cause:	
Description			
MDI共模辐射测试fail,用EMC rework的板子			

History

- #1 - 2023-03-16 17:28 - SZ HW Test-曾小文
- Category set to 依赖硬件解决bug
- #2 - 2023-04-11 19:15 - 项目二组_SD3 曾小文
- Status changed from New to RESOLVED
- 硬件rework后复测PASS
- #3 - 2023-04-11 19:16 - 项目二组_SD3 曾小文
- Status changed from RESOLVED to VERIFIED
- #4 - 2023-04-11 19:16 - 项目二组_SD3 曾小文
- Status changed from VERIFIED to CLOSED

Files

ChuangDa_FigureV03_PMA_Report_2023_03_10_15_37_36.pdf.pdf	1.26 MB	2023-03-13	SZ HW Test-曾小文
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